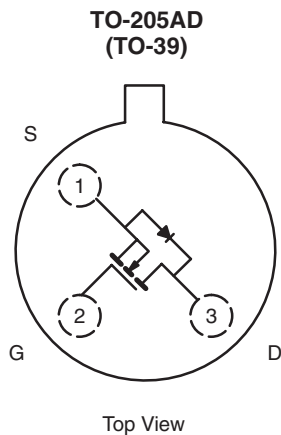


JAN Qualified N-Channel 60-V (D-S) MOSFET

PRODUCT SUMMARY			
$V_{(BR)DSS}$ Min (V)	$r_{DS(on)}$ Max (Ω)	$V_{GS(th)}$ (V)	I_D (A)
60	3 at $V_{GS} = 10$ V	0.8 to 2	0.99



FEATURES

- Military Qualified
- Low On-Resistance: 1.3 Ω
- Low Threshold: 1.7 V
- Low Input Capacitance: 35 pF
- Fast Switching Speed: 8 ns
- Low Input and Output Leakage

BENEFITS

- Guaranteed Reliability
- Low Offset Voltage
- Low-Voltage Operation
- Easily Driven Without Buffer
- High-Speed Circuits
- Low Error Voltage

APPLICATIONS

- Military Applications
- Direct Logic-Level Interface: TTL/CMOS
- Drivers: Relays, Solenoids, Lamps, Hammers, Displays, Memories, Transistors, etc.
- Battery Operated Systems
- Solid-State Relays

ABSOLUTE MAXIMUM RATINGS $T_A = 25$ °C, unless otherwise noted			
Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V_{DS}	60	V
Gate-Source Voltage	V_{GS}	± 20	
Continuous Drain Current ($T_J = 150$ °C)	I_D	$T_C = 25$ °C	0.99
		$T_C = 100$ °C	0.62
Pulsed Drain Current ^a	I_{DM}	3	A
Power Dissipation	P_D	$T_C = 25$ °C	6.25
		$T_A = 25$ °C	0.725
Thermal Resistance, Junction-to-Ambient ^b	R_{thJA}	170	°C/W
Thermal Resistance, Junction-to-Case	R_{thJC}	20	
Operating Junction and Storage Temperature Range	T_J, T_{stg}	- 55 to 150	°C

Notes:

- Pulse width limited by maximum junction temperature.
- Not required by military spec.

SPECIFICATIONS ^a T _A = 25 °C, unless otherwise noted						
Parameter	Symbol	Test Conditions	Limits			Unit
			Min	Typ ^b	Max	
Static						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{DS} = 0 V, I _D = 10 μA	60	75		V
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 1 mA	0.8	1.7	2	
		T _C = -55 °C			2.5	
Gate-Body Leakage	I _{GSS}	V _{DS} = 0 V, V _{GS} = ± 20 V			± 100	nA
		T _C = 125 °C			± 500	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 48 V, V _{GS} = 0 V			1	μA
		T _C = 125 °C			100	
On-State Drain Current	I _{D(on)}	V _{DS} = 10 V, V _{GS} = 10 V		2		A
Drain-Source On-Resistance ^c	r _{DS(on)}	V _{GS} = 5 V, I _D = 0.3 A		2	5	Ω
		V _{GS} = 10 V, I _D = 1 A		1.3	3	
		T _C = 125 °C		2.4	5.6	
Forward Transconductance ^c	g _{fs}	V _{DS} = 7.5 V, I _D = 0.525 A	170	350		mS
Diode Forward Voltage	V _{SD}	I _S = 0.99 A, V _{GS} = 0 V	0.7	0.8	1.6	V
Dynamic						
Input Capacitance	C _{iss}	V _{DS} = 25 V, V _{GS} = 0 V, f = 1 MHz		35	50	pF
Output Capacitance	C _{oss}			25	40	
Reverse Transfer Capacitance	C _{rss}			7	10	
Drain-Source Capacitance	C _{ds}			30		
Switching^d						
Turn-On Time	t _{ON}	V _{DD} = 25 V, R _L = 23 Ω		8	10	ns
Turn-Off Time	t _{OFF}	I _D ≅ 1 A, V _{GEN} = 10 V, R _g = 25 Ω		8.5	10	

Notes:

- T_A = 25 °C unless otherwise noted.
- FOR DESIGN AID ONLY, not subject to production testing.
- Pulse test: PW ≤ 300 μs duty cycle ≤ 2 %.
- Switching time is essentially independent of operating temperature.
- For typical characteristics curves see the 2N6659/2N6660, VQ1004J/P data sheet.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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